IPC ASSOCIATION ELECTRONIC	Material Compo © Copyright 2005. II International and Pan	PC, Bannockb	ourn, Illinois. A	all rights reserved untions.	nder both	This docume level parts, t	ent is a declara he declaration	tion of th encompa	e substances asses all lowe	within the	e manufactur terials for w	er listed it hich the m	em. Note: it anufacturer	f the item is an as has engineering	ssembly with loweresponsibility.	
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mf	g Informati	ion			
Supplie	r Information															
Company name* Company un				nique ID			Unique ID Authority					Response Date*				
onsemi													2023-06-08			
Contact N	lame	Title - Contact]	Phone - Contact*					Email - Contact*					
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorize	ed Representative*	Title - Representative]	Phone - Representative*				Email - Representative*						
Product-l	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date Version Manufacturing Si		ring Site	Weight*		UOM	Unit Type			
		FSFM300N Green Mo		Green Mode FPS	Aode FPS		2023-06-08		1	PH4		4	78.437	mg	Each	
Aanufa	cturing Proccess Informat	tion												•		
	Terminal Plating / Grid Array Material		Cerminal Base Alloy J-STD-020		-STD-020 MSI	L Rating	Peak Process Body Temperat		ture Max Time at Peak Temper		Temperatu	are Numb	er of Reflow Cyo	eles		
Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30		secono	is 3						
omments	3															
or more	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	led				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an						
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the this and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the				
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.6	mg	Supplier	Silicon (Si)	7440-21-3		1.6	mg
Die Attach	3.0	mg	Supplier	Silver (Ag)	7440-22-4		2.25	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.75	mg
Lead Frame	137.787	mg	Supplier	Silver (Ag)	7440-22-4		0.69	mg
			Supplier	Zinc (Zn)	7440-66-6		0.193	mg
			Supplier	Iron (Fe)	7439-89-6		3.6	mg
			Supplier	Copper (Cu)	7440-50-8		133	mg
			Supplier	Phosphorus (P)	7723-14-0		0.304	mg
Mold Compound-Black	321.0	mg		Phenolic Resin	proprietary data		25.68	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		25.68	mg
			Supplier	Carbon Black (C)	1333-86-4		1.605	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		268.035	mg
Plating	9.05	mg	Supplier	Tin (Sn)	7440-31-5		9.05	mg
Wire Bond - Au	6.0	mg	Supplier	Gold (Au)	7440-57-5		6	mg